



Bib Data Sheet


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SERIAL NUMBER 09/496,794	FILING DATE 02/02/2000 RULE -	CLASS 257	GROUP ART UNIT 2811	ATTORNEY DOCKET NO. MICT-0005-D1-US	
APPLICANTS John T. Moore, Boise, ID ; David L. Chapek, Merrimack, NH ;					
** CONTINUING DATA ***** THIS APPLICATION IS A DIV OF 08/993,329 12/18/1997 PAT 6,051,480 <i>040</i>					
** FOREIGN APPLICATIONS *****					
IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** ** 04/05/2000					
Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no 35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after met Verified and <i>Dough L. Moore</i> <i>DL</i> Acknowledged Examiner's Signature Initials		STATE OR COUNTRY ID	SHEETS DRAWING 3	TOTAL CLAIMS 9	INDEPENDENT CLAIMS 2
ADDRESS Trop Pruner & Hu 8554 Katy Freeway Suite 100 Houston ,TX 77024					
TITLE Trench isolation for semiconductor devices					
FILING FEE RECEIVED 690	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit		